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	Specification
Part	MC21605G12W-VNMLW
Number:	IVICZ TOOSO TZVV-VTNIVILVV
Version:	
Date:	
	Revision
No. Date	Description Item Page
desi	gn • manufacture • supply

### **Midas LCD Part Number System**

```
COG
                 132033
                                                                                  S
                                 Α
                                               6
                                                                                                 Т
                                                                                                        L
          2
                       3
                                 4
                                        5
                                               6
                                                      7
                                                             8
                                                                    9
                                                                                 10
                                                                                        11
                                                                                                12
                                                                                                       13
 1
                                                                                                              14
                                                                                                                      15
                                                                                                                             16
         =
                   MC: Midas Components
                   Blank: COB (chip on board) COG: chip on glass
                   No of dots
                                      (e.g. 240064 = 240 \times 64 \text{ dots})
                                                                             (e.g. 21605 = 2 \times 165 mm C.H.)
3
         =
         =
                   Series
4
         =
                   Series Variant:
                                       A to Z - see addendum
                                                          9: 9 o'clock
                                                                             12: 12 o'clock
         =
                   3: 3 o'clock
                                      6: 6 o'clock
6
                   S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)
7
         =
8
                   Character Set
                   Blank: Standard (English/Japanese)
                   C: Chinese Simplified (Graphic Displays only)
                   CB: Chinese Big 5 (Graphic Displays only)
                   H: Hebrew
                   K: European (std) (English/German/French/Greek)
                   L: English/Japanese (special)
                   M: European (English/Scandinavian)
                   R: Cyrillic
                   W: European (English/Greek)
                   U: European (English/Scandinavian/Icelandic)
         =
                   Bezel Height (where applicable /available)
                                                       LED Connection
                              Top of Bezel to Top
                                                                               Array or
                                                      Common (via pins 1
                                    of PCB
                                                                               Edge Lit
                                                             and 2)
                             9.5mm / not
                    Blank
                                                        via pins 15+ 16-
                                                                                 Array
                             applicable
                    2
                             8.9 \; \mathrm{mm}
                                                            Common
                                                                                 Array
                    3
                             7.8 \; \mathrm{mm}
                                                            Separate
                                                                                 Array
                    4
                             7.8 \text{ mm}
                                                            Common
                                                                                 Array
                    5
                            9.5 \text{ mm}
                                                            Separate
                                                                                 Array
                    6
                             7~\mathrm{mm}
                                                            Common
                                                                                 Array
                    7
                             7~\mathrm{mm}
                                                            Separate
                                                                                 Array
                    8
                                                            Common
                             6.4 \text{ mm}
                                                                                 Edge
                             6.4 \text{ mm}
                                                            Separate
                                                                                 Edge
                             5.5 \text{ mm}
                                                            Common
                                                                                 Edge
                    A
                    В
                             5.5 \text{ mm}
                                                            Separate
                                                                                 Edge
                    D
                             6.0mm
                                                            Separate
                                                                                 Edge
                    E
                             5.0mm
                                                            Separate
                                                                                 Edge
                    \mathbf{F}
                             4.7mm
                                                            Common
                                                                                 Edge
                    \mathbf{G}
                             3.7mm
                                                            Separate
                                                                                  \mathbf{EL}
                             7 \text{ mm}
                                                            Separate
                                                                                 Edge
                   T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN V: VA (Vertically Aligned)
10
11
         =
                   P: Positive N: Negative
12
                   R: Reflective M: Transmissive T: Transflective
         =
                   Backlight: Blank: Reflective L: LED
13
         =
                   Backlight Colour: Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.
14
                   Driver Chip:
                                      Blank: Standard I: I<sup>2</sup>C S: SPI T: Toshiba T6963C A: Avant SAP1024B
                                                                                                                      R: Raio RA6963
15
         =
                   Voltage Variant: e.g. 3 = 3v
16
         =
```

# 2. General Specification

The Features is described as follow:

■ Module dimension: 80.0 x 36.0 x 13.5 (max.) mm<sup>3</sup>

■ View area: 66.0 x 16.0 mm<sup>2</sup>

Active area: 56.20 x 11.5 mm<sup>2</sup>

Number of Characters:16 characters x 2 Lines

■ Dot size: 0.55 x 0.65 mm<sup>2</sup>

■ Dot pitch: 0.60 x 0.70 mm²

■ Character size: 2.95 x 5.55 mm<sup>2</sup>

■ Character pitch: 3.55 x 5.95 mm<sup>2</sup>

■ LCD type: VA Negative Transmissive

■ Duty: 1/16

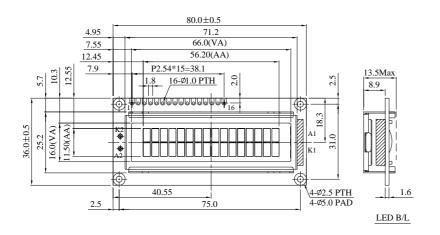
■ View direction: 12 o'clock

■ Backlight Type: LED, High light White

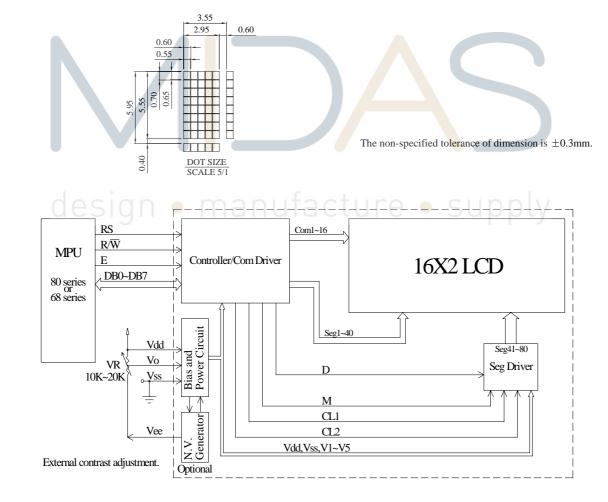
## 4. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V <sub>SS</sub>	0V	Ground
2	$V_{DD}$	5.0V	Supply Voltage for logic
3	VO	(Variable)	Contrast Adjustment
4	RS	H/L	H: DATA, L: Instruction code
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	D <mark>at</mark> a bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	Vee		Negative Voltage Output
16	K	<del>19<u>n</u> •</del>	LED anulacture • Suppty

## 5. Outline Dimension & Block Diagram



PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	RS
5	R/W
6	Е
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	Vee
16	K



Character located DDRAM address DDRAM address

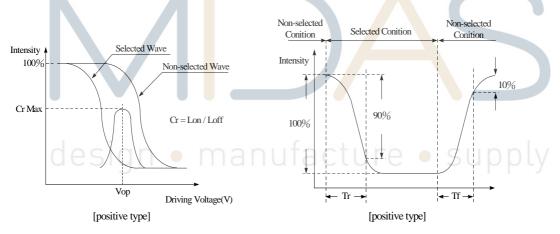
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F 40 41 42 43 44 45 46 47 48 49 4A 4B 4C 4D 4E 4F

# **6. Optical Characteristics**

ltem	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧10	_	60	_	ψ= 180°
View Angle	θ	CR≧10	_	25	_	ψ= 0°
view, migre	θ	CR≧10	_	40 –		ψ= 90°
	θ	CR≧10	_	40	_	ψ= 270°
Contrast Ratio	CR	_	10	_	_	_
Response Time	T rise	_	_	300	350	ms
	T fall	_	_	300	350	ms

**Definition of Operation Voltage (Vop)** 

Definition of Response Time (Tr, Tf)

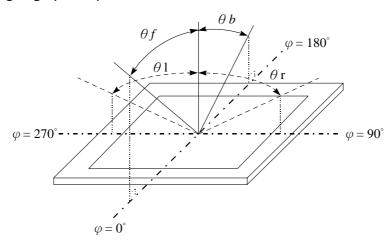


**Conditions:** 

Operating Voltage : Vop Viewing Angle( $\theta$ ,  $\phi$ ) :  $0^{\circ}$ ,  $0^{\circ}$ 

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

### Definition of viewing angle(CR≥2)



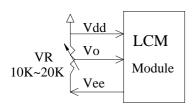
# 7. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T <sub>OP</sub>	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T <sub>ST</sub>	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V <sub>IN</sub>	-0.3	_	V <sub>DD</sub> +0.3	V
Supply Voltage For Logic	VDD-V <sub>SS</sub>	-0.3		5.5	V
Supply Voltage For LCD	$V_{DD}$ - $V_0$	V <sub>SS</sub> -0.3	_	V <sub>SS</sub> +7.0	V

## 8. Electrical Characteristics

ltem	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V <sub>DD</sub> -V <sub>SS</sub>	-)/	4.5	5.0	5.5	V
Supply Voltage For LCD		Ta=-20°C	_		_	V
*Note	$V_{DD}$ - $V_0$	Ta=25℃	6.2	6.5	6.8	V
design	<ul><li>mar</li></ul>	Ta=70℃	ure	• <del>-</del> 5l	ıp <del>p</del> l	y v
Input High Volt.	$V_{IH}$	_	2.5	_	$V_{DD}$	V
Input Low Volt.	V <sub>IL</sub>	_	-0.3	_	0.6	V
Output High Volt.	V <sub>OH</sub>	_	3.9	_	_	V
Output Low Volt.	$V_{OL}$	_	_	_	0.4	V
Supply Current	I <sub>DD</sub>	V <sub>DD</sub> =5.0V	—	2.0	_	mA

<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board



# 9. Backlight Information

## **Specification**

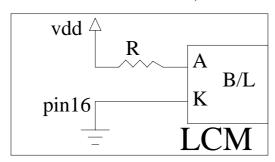
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	48	60	72	mA	V=5.0V
Supply Voltage	V	4.9	5.0	5.1	V	_
Reverse Voltage	VR	_	_	5	V	_
Luminance (Without LCD)	IV	1440	1800	_	CD/M <sup>2</sup>	ILED=60mA
LED Life Time (For Reference only)	_	_	50K	_	Hr.	ILED=60mA 25℃,50-60%RH, (Note 1)
Color	White(hig	h <mark>lig</mark> ht)				

Note: The LED of B/L is drive by current only, drive voltage is for reference only.

drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

Drive from Vdd, Pin 16



# 10. Reliability

## Content of Reliability Test (wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	200hrs	-
Low Temperature Operation	temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60℃,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20℃/ <b>70</b> ℃ 10 cycles	-
desig	Endurance test applying the vibration during transportation and using.	fixed amplitude: 15mm Vibration. Frequency: 10~55Hz. One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS= 1.5kΩ CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

## 11.IC Information

## 11.1. Function Description

#### **SYSTEM INTERFACE (Parallel 8-bit bus and 4-bit bus)**

This chip has all four kinds interface type with MPU: IIC, 4SPI, 4-bit bus and 8-bit bus. Serial and parallel buses (4-bit/8-bit) are selected by IF1 and IF0 input pins, and 4-bit bus and 8-bit bus is selected by DL bit in the instruction register.

During read or write operation, two 8-bit registers are used. One is data register (DR); the other is instruction register (IR). The data register (DR) is used as temporary data storage place for being written into or read from DDRAM/CGRAM, target RAM is selected by RAM address setting instruction. Each internal operation, reading from or writing into RAM, is done automatically.

So to speak, after MPU reads DR data, the data in the next DDRAM/CGRAM address is transferred into DR automatically. Also after MPU writes data to DR, the data in DR is transferred into DDRAM/CGRAM automatically.

The Instruction register (IR) is used only to store instruction code transferred from MPU. MPU cannot use it to read instruction data.

IR: Instruction Register.

DR: Data Register.

RS	R/W	Operation
0	0	Instruction write operation (MPU writes Instruction code into IR)
0	1	Read busy flag (DB7) and address counter (DB0 - DB6)
1	0	Data write operation (MPU writes data into DR
1	1	Data read operation (MPU reads data from DR)

#### BUSY FLAG (BF) (only support parallel 8-bit bus and 4-bit bus)

When BF = "High", it indicates that the internal operation is being processed. So during this time the next instruction cannot be accepted. BF can be read, when RS = Low and R / W = High (Read Instruction Operation); through DB7 before executing the next instruction, be sure that BF is not High.

#### **DISPLAY DATA RAM (DDRAM)**

DDRAM stores display data of maximum 80 x 8 bits (80 characters). DDRAM address is set in the address counter (AC) as a hexadecimal number. (Refer to Figure 1.)

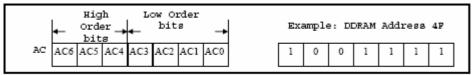


Figure 1 DDRAM Address

Since DDRAM has 8 bits data. It is possible to access 256 CGROM/CGRAM fonts.

#### 1-line display (N = 0) (Figure 2)

When there are fewer than 80 display characters, the display begins at the head position. For example, if using only the Controller, 8 characters are displayed. See Figure 3.

When the display shift operation is performed, the DDRAM address shifts. See Figure 3.

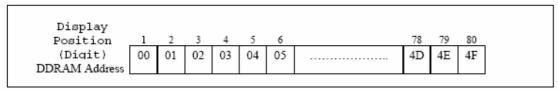


Figure 2 1-Line Display

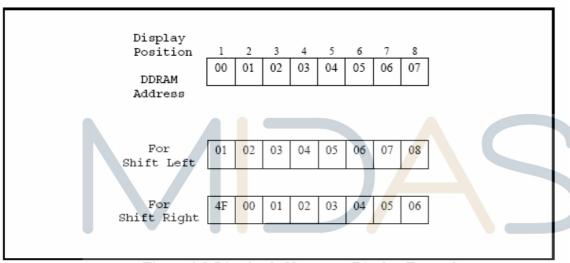


Figure 3 1-Line by 8-Character Display Example

### 2-line display (N = 1) (Figure 4)

Case 1: When the number of display characters is less than 40 x 2 lines, the two lines are displayed from the head. Note that the first line end address and the second line start address are not consecutive. For example, when just the Controller is used, 8 characters x 2 lines are displayed. See Figure 5.

When display shift operation is performed, the DDRAM address shifts. See Figure 5.

Display Position	1	2	3	4	5	6	38	39	40	
DDRAM	00	01	02	03	04	05	 25	26	27	
Address (hexadecimal)	40	41	42	43	44	45	 65	66	67	

Figure 4 2-Lines Display

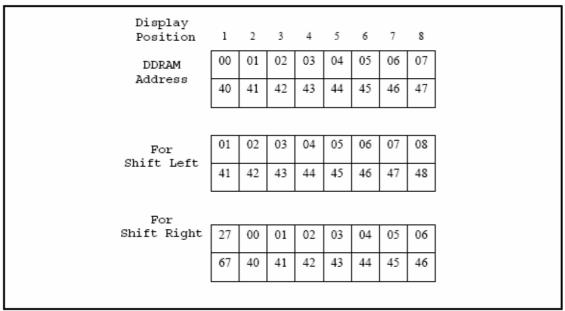


Figure 5 2-Lines by 8-Character Display Example

Case 2: For a 16-character x 2-line display, the Controller can be extended using one 40-output extension driver. See Figure 6.

When display shift operation is performed, the DDRAM address shifts. See Figure 6.

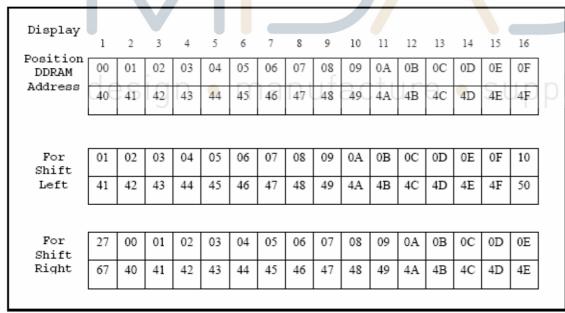


Figure 6 2-Lines by 16-Character Display Example

#### **TIMING GENERATION CIRCUIT**

Timing generation circuit generates clock signals for the internal operations.

### **ADDRESS COUNTER (AC)**

Address Counter (AC) stores DDRAM/CGRAM address, transferred from IR.

After writing into (reading from) DDRAM/CGRAM/SEGRAM, AC is automatically increased (decreased) by 1.

When RS = "Low" and R/W = "High", AC can be read through DB0-DB6

#### **CURSOR/BLINK CONTROL CIRCUIT**

It controls cursor/blink ON/OFF and black/white inversion at cursor position.

#### **LCD DRIVER CIRCUIT**

LCD Driver circuit has 16 common and 40 segment signals for 2-line display (N=1) or 8 common and 40 segments for 1-line display (N=0) for LCD driving.

Data from CGRAM/CGROM is transferred to 40 bit segment latches serially, and then it is stored to 40 bit shift latch.

#### **CGROM (CHARACTER GENERATOR ROM)**

CGROM has 10,240 bits (256 characters x 5 x 8 dot)

#### CGRAM (CHARACTER GENERATOR RAM)

CGRAM has up to 5 \_ 8 dots 8 characters. By writing font data to CGRAM, user defined character can be used (refer to Table 2).

#### 5 x 8 dots Character Pattern

Table 2. Relationship between Character Code (DDRAM) and Character Pattern (CGRAM)

	CIL	-	<del>- 1</del>	70.0	77.1			_	- 01	272 4 7	- 1 5		$\rightarrow$	-		4	075.4	27.0	_	_		34
	Chai	acter	Code	(DD	KAN	l data	.)	_	CC	JRAN		iress		_		(	GRA	M D	ata			Pattern
D7	D6	D5	D4	D3	D2	D1	D0	Α5	Α4	А3	A2	A1	Α0	P7	P6	P5	P4	Р3	P2	P1	P0	Number
0	0	0	0	0	0	0	0	0	0	0	0	0	0	X	X	Х	0	1	1	1	0	Pattern 1
-	-	-	-	-	0	0	0	۱.	-	-	0	0	1	-	-	-	1	0	0	0	1	
-	-	-	-	-	0	0	0	-	-	-	0	1	0	١.	-	-	1	0	0	0	1	
-	-	-	-	-	0	0	0	۱.	-	-	0	1	1	-	-	-	1	1	1	1	1	
-	-	-	-	-	0	0	0	۱.	-	-	1	0	0	١.	-	-	1	0	0	0	1	
	-	-	-	-	0	0	0	۱.	-	-	1	0	1	۱.			1	0	0	0	1	
	_	_	_	_	0	0	0	١.	_	_	1	1	0	١.			1	0	0	0	1	
_	_	_	_	_	0	0	0	١.	_		1	1	1	١.	_	_	0	0	0	0	0	
				_				$\vdash$	_		<u> </u>		-	$\vdash$				-			_	
									_					l				_				
0	0	0	0	0	1	1	1	1	1	1	0	0	0	Х	Х	X	- 1	0	0	0	-1	Pattern 8
		-	-		1	1	1	_	1	1	0	0	1		74	71	1	0	0	0	1	I ditterii o
-	-	-	-	-	1	1	1	-	-	-	0	1	0	[	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	-	-		0	1	1	1	-	-	1	1	1	1	1	
-	-	-	-	-	1	1	1	-	-	-	1	1	1	-	-	-	1	- 1			1	
-	-	-	-	-	1	1	1	-	-	-	1	0	0	-	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	-	-	-	1	0	1	٠	-	-	1	0	0	0	1	
-	-	-	-	-	1	1	1	٠.	-	-	1	1	0	٠.	-	-	-1	0	0	0	1	
-	-	-	-	-	1	1	1	l -	-	-	1	1	1	-	-	-	0	0	0	0	0	

#### Notes:

- 1. Character code bits 0 to 2 correspond to CGRAM address bits 3 to 5 (3 bits: 8 types).
- 2. CGRAM address bits 0 to 2 designate the character pattern line position. The 8th line is the cursor position and its display is formed by a logical OR with the cursor. Maintain the 8th line

data, corresponding to the cursor display position, at 0 as the cursor display. If the 8th line data is 1, 1 bit will light up the 8th line regardless of the cursor presence.

- 3. Character pattern row positions correspond to CGRAM data bits 0 to 4 (bit 4 being at the left).
- 4. As shown Table 2, CGRAM character patterns are selected when character code bits 4 to 7 are all 0 and MW=0. However, since character code bit 3 has no effect, the H display example above can be selected by either character code 00H or 08H.
- 5. 1 for CGRAM data corresponds to display selection and 0 to non-selection.
- "-": Indicates no effect.



## 11.2.Instruction Table

Instruction	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	Description Time (540KHz)
Read display data	1	1				Read	data				Read data into DDRAM/CGRAM/SEGRAM	18.5us
Write display data	1	0				Write	e data				Write data into DDRAM/CGRAM/SEGRAM	18.5us
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM, and set DDRAM address to "00H" from AC	0.76ms
Return Home	0	0	0	0	0	0	0	0	1	Х	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	0.76ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Assign cursor moving direction and specify display shift. These operations are performed during data read and write.  I/D="1": increment I/D="0": decrement	18.5us
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	Set Display /Cursor/Blink On/OFF D="1": display on D="0": display off  C="1": cursor on C="0": cursor off  B="1": blink on B="0": blink off	18.5us
Cursor or Display shift	0	0	0	0	0	1	S/C	R/L	X	X	Cursor or display shift S/C="1": display shift S/C="0": cursor shift R/L="1": shift to right R/L="0": shift to left	18.5us
Function Set	0	0	0	0	1	DL	N	d C F	X		Set Interface Data Length DL= 8-bit interface/ 4-bit interface N = 2-line/1-line display F= 5x8 Font Size / 5x11Font Size	18.5us
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	18.5us
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	18.5us
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Can know internal operation is ready or not by reading BF. The contents of address counter can also be read. BF="1": busy state BF="0": ready state	0us

#### **Clear Display**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	0	1

Clear all the display data by writing "20H" (space code) to all DDRAM address, and set DDRAM address to "00H" into AC (address counter). Return cursor to the original status; namely, bring the cursor to the left edge on first line of the display. Make entry mode increment (I/D = "1").

#### **Return Home:**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	0	0	0	0	0	0	1	Х	1

Return Home is cursor return home instruction. Set DDRAM address to "00H" into the address counter. Return cursor to its original site and return display to its original status, if shifted. A content of DDRAM does not change.

#### **Entry Mode Set:**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	1	I/D	S

Set the moving direction of cursor and display.

I/D: Increment/decrement of DDRAM address (cursor or blink)

I/D = 1: cursor/blink moves to right and DDRAM address is increased by 1.

I/D = 0: cursor/blink moves to left and DDRAM address is decreased by 1.

\* CGRAM operates the same as DDRAM, when read/write from or to CGRAM

#### S: Shift of entire display

When DDRAM read (CGRAM read/write) operation or S = "Low", shift of entire display is not performed.

If S= "High" and DDRAM write operation, shift of entire display is performed according to I/D value (I/D = "1": shift left, I/D = "0": shift right).

s	I/D	Description
Н	Н	Shift the display to the left
Н	L	Shift the display to the right

#### **Display ON/OFF**

	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
ı	0	0	0	0	0	0	1	D	С	В

Control display/cursor/blink ON/OFF 1 bit register.

D: Display ON/OFF control bit.

D = 1: entire display is turned on.

D = 0: display is turned off, but display data is remained in DDRAM.

#### C: Cursor ON/OFF control bit.

C = 1: cursor is turned on.

C = 0: cursor is disappeared in current display, but I/D register remains its data.

#### B: Cursor Blink ON/OFF control bit.

B = 1: cursor blink is on, that performs alternate between all the high data and display character at the cursor position. If fosc has 540 kHz frequency, blinking has 185 ms interval.

B = 0: blink is off.

#### **Cursor or Display Shift**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	1	S/C	R/L	-	

Without writing or reading of display data, shift right/left cursor position or display. This instruction is used to correct or search display data (refer to Table 4). During 2-line mode display, cursor moves to the 2nd line after 40th digit of 1st line.

Note that display shift is performed simultaneously by the shift enable instruction. When displayed data is shifted repeatedly, all display lines shifted simultaneously. When display shift is performed, the contents of address counter are not changed.

Table 4. Shift Patterns According to S/C and R/L Bits

S/C	R/L	Operation
0	0	Shift cursor to the left, address counter is decreased by 1
0	00101	Shift cursor to the right, address counter is increased by 1
1	0	Shift all the display to the left, cursor moves according to the display
1	1	Shift all the display to the right, cursor moves according to the display

#### **Function Set**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	DL	N	F	Х	Х

#### DL: Interface data length control bit

When DL = "High", it means 8-bit bus mode with MPU.

When DL = "Low", it means 4-bit bus mode with MPU. So to speak, DL is a signal to select 8-bit or 4-bit bus mode.

When 4-bit bus mode, it needs to transfer 4-bit data by two times.

IF using IIC and 4-SPI interface, DL bit must be setting to "1"

#### N: Display line number control bit

When N = "Low", it means 1-line display mode.

When N = "High", 2-line display mode is set.

#### F: Display font type control bit

When F = "Low", it means 5 x 8 dots format display mode

When F = "High", 5 x11 dots format display mode.

N	F	No. of Display Lines	Character Font	Duty Factor
L	L	1	5x8	1/8
L	Н	1	5x11	1/11
Н	х	2	5x8	1/16

#### **Set CGRAM Address**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

Set CGRAM address to AC.

This instruction makes CGRAM data available from MPU.

#### **Set DDRAM Address**

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0

Set DDRAM address to AC.

This instruction makes DDRAM data available from MPU.

When 1-line display mode (N=0), DDRAM address is from "00H" to "4FH"

In 2-line display mode (NW = 0), DDRAM address in the 1st line is from "00H" - "27H", and DDRAM address in the 2nd line is from "40H" - "67H".

# Read Busy Flag and Address (only support parallel 8-bit bus and 4 bit bus)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0

This instruction shows whether Controller is in internal operation or not. If the resultant BF is "high", it means the internal operation is in progress and you have to wait until BF to be Low, and then the next instruction can be performed. In this instruction you can read also the value of address counter.

#### Write Data to RAM

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
1	0	D7	D6	D5	D4	D3	D2	D1	D0	1

Write binary 8-bit data to DDRAM/CGRAM/SEGRAM.

The selection of RAM from DDRAM, CGRAM, is set by the previous address set instruction: DDRAM address set, CGRAM address set. RAM set instruction can also determine the AC direction to RAM.

After write operation, the address is automatically increased/decreased by 1, according to the

entry mode.

**Read Data from RAM** (only support parallel 8-bit bus and 4 bit bus)

	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
-	1	1	D7	D6	D5	D4	D3	D2	D1	D0	1

Read binary 8-bit data from DDRAM/CGRAM.

The selection of RAM is set by the previous address set instruction. If address set instruction of RAM is not performed before this instruction, the data that read first is invalid, because the direction of AC is not determined.

If you read RAM data several times without RAM address set instruction before read operation, you can get correct RAM data from the second, but the first data would be incorrect, because there is no time margin to transfer RAM data.

In case of DDRAM read operation, cursor shift instruction plays the same role as DDRAM address set instruction: it also transfer RAM data to output data register. After read operation address counter is automatically increased/decreased by 1 according to the entry mode. After CGRAM read operation, display shift may not be executed correctly.

\* In case of RAM write operation, after this AC is increased/decreased by 1 like read operation. In this time, AC indicates the next address position, but you can read only the previous data by read instruction.

# OUTLINE design • manufacture • supply

To overcome the speed difference between internal clock of Controller and MPU clock, Controller performs internal operation by storing control information to IR (Instruction Register) or DR (data Register).

The internal operation is determined according to the signal from MPU, composed of read/write and data bus.

I Nstruction can be divided largely four kinds;

- \*Controller function set instructions (set display methods, set data length, etc.)
- \*Address set instructions to internal RAM
- \*Data transfer instructions with internal RAM
- \*Others

The address of internal RAM is automatically increased or decreased by 1.

**NOTE:** During internal operation, Busy Flag (DB7) is read high. Busy Flag check must be preceded the next instruction.

Busy flag check must be proceeded the next instruction.

When an MPU program with Busy Flag (DB7) checking is made, 1/2 Fosc (is necessary) for executing the next instruction by the falling edge of the "E" signal after the Busy Flag (DB7)

goes to "Low".

#### **INTERFACE WITH MPU**

Controller can transfer data in bus mode (4-bit or 8-bit) or serial mode with MPU. In case of 4-bit bus mode, data transfer is performed by two times to transfer 1 byte data.

. When interfacing data lengths are 4-bit, only 4 ports, from DB4 - DB7, are used as data bus. At first higher 4-bit (in case of 8-bit bus mode, the contents of DB4 - DB7) are transferred, and then lower 4- bit (in case of 8-bit bus mode, the contents of DB0 - DB3) are transferred. So transfer is performed by two times.

Busy Flag outputs "High" after the second transfer are ended.

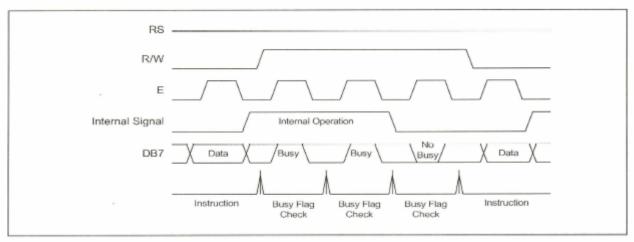
- When interfacing data length are 8-bit, transfer is performed at a time through 8 ports, from DB0 DB7.
- Interface is selected by IF1,IF0 pins (refer to **Bonding Note for IF1, IF0** on Page 10)

IF1	IF0	Interface select	
open	open	6800 8/4 bit	
open	Bonding to VDD	IIC	
Bonding to VDD	open	4-line SPI	

#### INTERFACE WITH MPU IN BUS MODE

#### Interface with 8-bit MPU

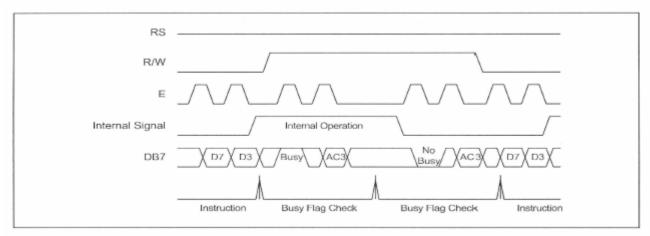
If 8-bits MPU is used, Controller can connect directly with that. In this case, port E, RS, R/W and DB0 to DB7 need to interface each other. Example of timing sequence is shown below.



Example of 8-bit Bus Mode Timing Sequence

#### Interface with 4-bit MPU

If 4-bit MPU is used, Controller can connect directly with this. In this case, port E, RS, R/W and DB4 - DB7 need to interface each other. The transfer is performed by two times. Example of timing sequence is shown below.

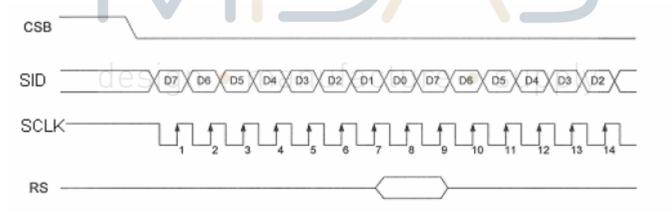


Example of 4-bit Bus Mode Timing Sequence

#### For serial interface data, bus lines (DB5 to DB7) are used. 4-Line SPI

If 4-Pin SPI mode is used, CSB (DB5), SID (DB7), SCLK (DB6), and RS are used. They are chip selection; serial input data, serial clock input, and data/instruction section, relatively. The example of timing sequence is shown below.

### **Example of timing sequence**



Note: Following is the master SPI clock mode of MPU.

Idle state for clock is a high level, data transmitted on rising edge of SCLK, and data is hold during low level.

### For serial interface data, bus lines (DB5(CSB), DB6(SDA) and DB7(SCL)) are used.

#### **IIC** interface

The IIC interface receives and executes the commands sent via the IIC Interface. It also receives RAM data and sends it to the RAM.

The IIC Interface is for bi-directional, two-line communication between different ICs or modules.

Serial data line

SDA (DB6) and a Serial clock line SCL (DB7) must be connected to a positive supply via a pull-up resistor.

Data transfer may be initiated only when the bus is not busy.

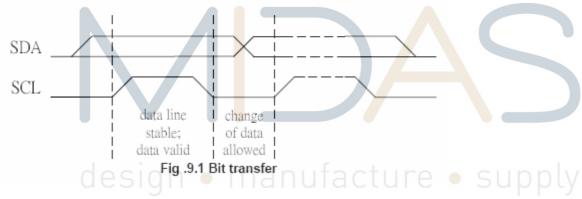
- \*The CSB (DB5) Pin must be setting to "VSS".
- \* When IIC interface is selected, the DL register must be set to "1".

#### **BIT TRANSFER**

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the

HIGH period of the clock pulse because changes in the data line at this time will be interpreted as a control

signal. Bit transfer is illustrated in Fig.9.1



#### START AND STOP CONDITIONS

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P). The START and STOP conditions are illustrated in

Fig.9.2

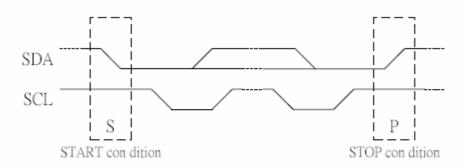


Fig .9.2 Definition of START and STOP conditions

#### SYSTEM CONFIGURATION

The system configuration is illustrated in Fig.9.3

- · Transmitter: the device, which sends the data to the bus
- · Receiver: the device, which receives the data from the bus
- · Master: the device, which initiates a transfer, generates clock signals and terminates a transfer
- · Slave: the device addressed by a master
- · Multi-Master: more than one master can attempt to control the bus at the same time without corrupting the message
- · Arbitration: procedure to ensure that, if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted
- · Synchronization: procedure to synchronize the clock signals of two or more devices.

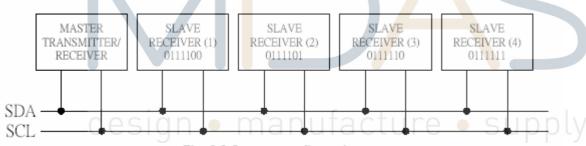


Fig .9.3 System configuration

#### **ACKNOWLEDGE**

Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an Acknowledge after the reception of each byte. A master receiver must also generate an Acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the Acknowledge related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an end-of-data to the transmitter by not generating an Acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition. Acknowledgement on the IIC

Interface is illustrated in Fig.9.4

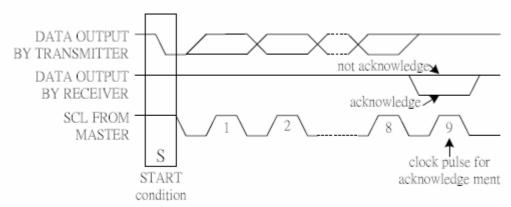


Fig .9.4 Acknowledgement on the 2-line Interface

#### **IIC Interface protocol**

The Controller supports command, data write addressed slaves on the bus.

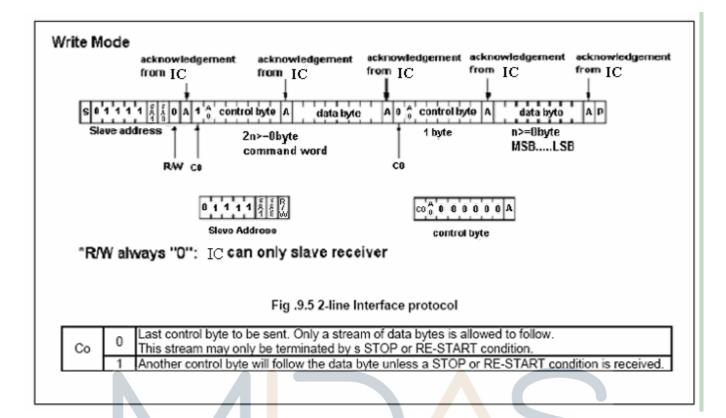
Before any data is transmitted on the IIC Interface, the device, which should respond, is addressed first.

Four 7-bit slave addresses (0111100, 0111101, 0111110 and 0111111) are reserved for the Controller. The least significant bit of the slave address is set by connecting the input SA0 (DB0) and SA1 (DB1) to either logic 0 (VSS) or logic 1 (VDD).

The IIC Interface protocol is illustrated in Figure.9.5

The sequence is initiated with a START condition (S) from the IIC Interface master, which is followed by the slave address. All slaves with the corresponding address acknowledge in parallel, all the others will ignore the IIC Interface transfer. After acknowledgement, one or more command words follow which define the status of the addressed slaves.

A command word consists of a control byte, which defines Co and A0, plus a data byte. The last control byte is tagged with a cleared most significant bit (i.e. the continuation bit Co). After a control byte with a cleared Co bit, only data bytes will follow. The state of the A0 bit defines whether the data byte is interpreted as a command or as RAM data. All addressed slaves on the bus also acknowledge the control and data bytes. After the last control byte, depending on the A0 bit setting; either a series of display data bytes or command data bytes may follow. If the A0 bit is set to logic 1, these display bytes are stored in the display RAM at the address specified by the data pointer. The data pointer is automatically updated and the data is directed to the intended Controller device. If the A0 bit of the last control byte is set to logic 0, these command bytes will be decoded and the setting of the device will be changed according to the received commands. Only the addressed slave makes the acknowledgement after each byte. At the end of the transmission the IIC interface-bus master issues a STOP condition (P). If no acknowledge is generated by the master after a byte, the driver stops transferring data to the master.



design • manufacture • supply

#### **INITIALIZING**

#### **INITIALIZING BY INTERNAL RESET CIRCUIT**

When the power is turned on, Controller is initialized automatically by power on reset circuit. During the initialization, the following instructions are executed, and BF (Busy Flag) is kept "High" (busy state) to the end of initialization.

#### **Clear Display Instruction**

Write "20H" to all DDRAM

#### **Set Functions Instruction**

DL = 1: 8-bit bus mode

N = 0: 1-line display

 $F = 0: 5 \times 8$  dot character font

### **Display ON/OFF Instruction**

D = 0: Display OFF

C = 0: Cursor OFF

B = 0: Blink OFF

#### **Set Entry Mode Instruction**

I/D = 1: Increment by 1

S = 0: No entire display shift

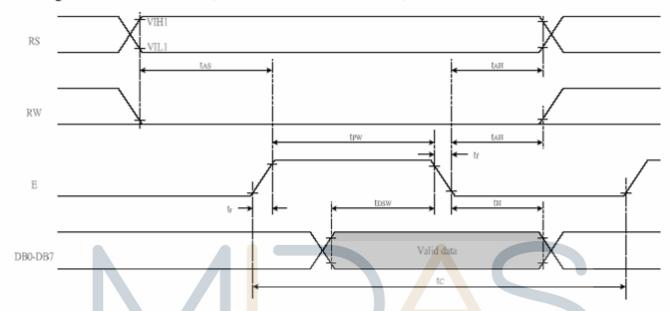
#### Note:

If the electrical characteristics conditions listed under the table Power Supply Conditions Using Internal Reset Circuit are not met, the internal reset circuit will not operate normally and will fail to initialize the Controller. For such a case, initialization must be performed by the MPU as explain by the following figure.

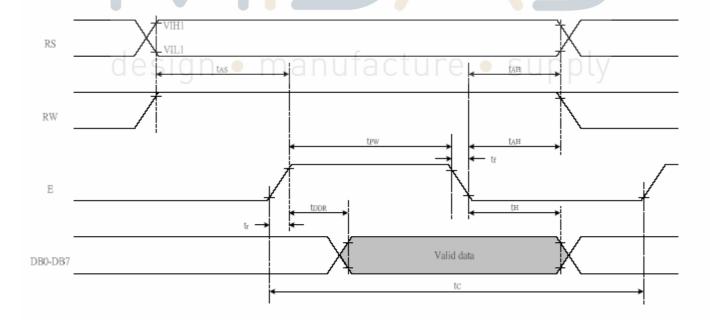
# **11.3.Timing Characteristics**

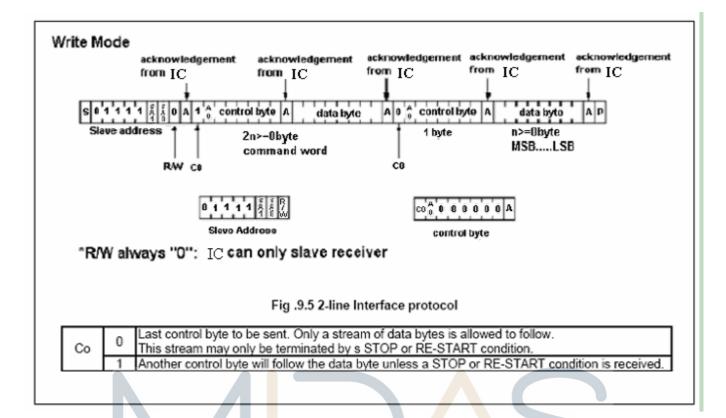
## **Timing Characteristics**

Writing data from MPU to IC (Parallel 8-bit bus and 4-bit bus)



## Reading data from IC to MPU(Parallel 8-bit bus and 4-bit bus)





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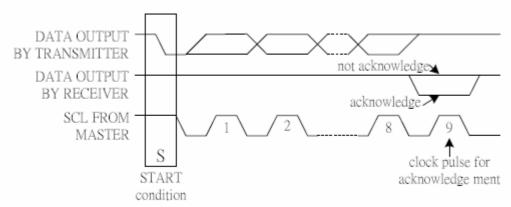


Fig .9.4 Acknowledgement on the 2-line Interface

#### **IIC Interface protocol**

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Four 7-bit slave addresses (0111100, 0111101, 0111110 and 0111111) are reserved for the Controller. The least significant bit of the slave address is set by connecting the input SA0 (DB0) and SA1 (DB1) to either logic 0 (VSS) or logic 1 (VDD).

The IIC Interface protocol is illustrated in Figure.9.5

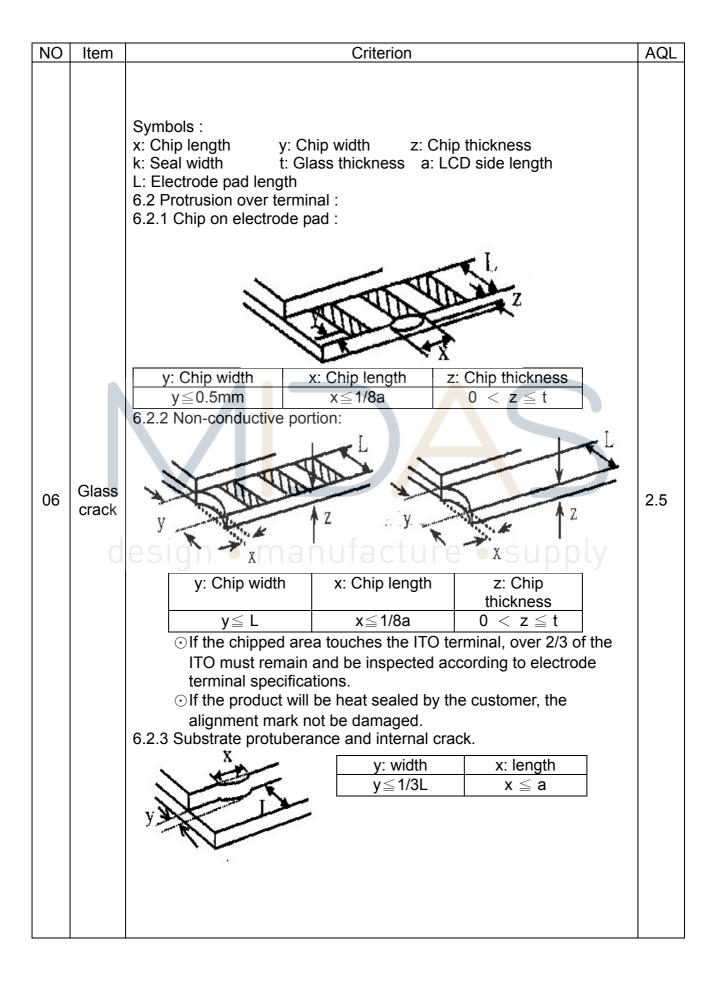
The sequence is initiated with a START condition (S) from the IIC Interface master, which is followed by the slave address. All slaves with the corresponding address acknowledge in parallel, all the others will ignore the IIC Interface transfer. After acknowledgement, one or more command words follow which define the status of the addressed slaves.

A command word consists of a control byte, which defines Co and A0, plus a data byte. The last control byte is tagged with a cleared most significant bit (i.e. the continuation bit Co). After a control byte with a cleared Co bit, only data bytes will follow. The state of the A0 bit defines whether the data byte is interpreted as a command or as RAM data. All addressed slaves on the bus also acknowledge the control and data bytes. After the last control byte, depending on the A0 bit setting; either a series of display data bytes or command data bytes may follow. If the A0 bit is set to logic 1, these display bytes are stored in the display RAM at the address specified by the data pointer. The data pointer is automatically updated and the data is directed to the intended Controller device. If the A0 bit of the last control byte is set to logic 0, these command bytes will be decoded and the setting of the device will be changed according to the received commands. Only the addressed slave makes the acknowledgement after each byte. At the end of the transmission the IIC interface-bus master issues a STOP condition (P). If no acknowledge is generated by the master after a byte, the driver stops transferring data to the master.

# 13. Inspection specification

NO	Item			Criterion		AQL	
01	Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ul>					
02	Black or white spots on LCD (display only)	than three v	<ul> <li>.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>				
03	LCD black spots, white spots, contaminatio		Round type: As following drawing $\Phi = (x + y) / 2$				
	n (non-display)	3.2 Line type :	(As follow Length	ring drawing) Width W≦0.02	Acceptable Q TY Accept no		
		→ı <sub>L</sub> +←		VV <u>=</u> 0.02	dense	2.5	
			L≦3.0	0.02 <w≦0.03< td=""><td>2</td><td></td></w≦0.03<>	2		
			L≦2.5	0.03 <w≦0.05< td=""><td></td><td></td></w≦0.05<>			
				0.05 <w< td=""><td>As round type</td><td></td></w<>	As round type		
	Dalarina	Polarizer bubbles bubbles  If bubbles are visi judge using black specifications, not easy to find, must check in specify direction.		Size Φ Φ≦0.20	Acceptable Q TY Accept no		
04				$0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	dense 3 2 0 3	2.5	

Symbols Define: x: Chip length x: Chip length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:    Chipped glass   1/2t < z ≤ 2t   Not exceed 1/3k   x ≤ 1/8a
Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:    Z: Chip thickness   y: Chip width   x: Chip length     Z≤ 1/2t   Not over viewing   x≤ 1/8a     area   1/2t < z≤ 2t   Not exceed 1/3k   x≤ 1/8a     Z ≤ 1/2t   Not over viewing   x≤ 1/8a     Area   1/2t < z≤ 2t   Not exceed 1/3k   x≤ 1/8a     Area   1/2t < z≤ 2t   Not exceed 1/3k   x≤ 1/8a     Area   1/2t < z≤ 2t   Not exceed 1/3k   x≤ 1/8a     Area   1/2t < z≤ 2t   Not exceed 1/3k   x≤ 1/8a



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB · COB design	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No exidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul> X * Y<=2mm²	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
NO 12	General appearance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it causes the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 LCD pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.05

# 14. Precautions in use of LCD Modules



- 1. Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- 2. Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- 3. Don't disassemble the LCM.
- 4. Don't operate it above the absolute maximum rating.
- 5. Don't drop, bend or twist LCM.
- 6. Soldering: only to the I/O terminals.
- 7. Storage: please storage in anti-static electricity container and clean environment.
- 8. T aaæ have the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- 9. T a ae have the right to change the PCB Rev.

## 15. Material List of Components for RoHs

1. T a é ÁÖã] | sê • hereby declares that all of or part of products, including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material (Cd) (Pb) (Hg) (Cr6+) PBBs PBDE								
Limited         100         1000         1000         1000         1000         1000         1000         1000         ppm         ppm								
Above limited value is set up according to RoHS.								

- 2. Process for RoHS requirement:
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp. :

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°€;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

## 16. Recommendable storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module